SQM40022EM

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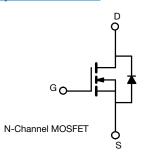
Automotive N-Channel 40 V (D-S) 175 °C MOSFET



| PRODUCT SUMMARY | | | | |
|--|-----------|--|--|--|
| V _{DS} (V) | 40 | | | |
| $R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$ | 0.00163 | | | |
| I _D (A) | 150 | | | |
| Configuration | Single | | | |
| Package | TO-263-7L | | | |

FEATURES

- TrenchFET® power MOSFET
- · Package with low thermal resistance
- 100 % $R_{\rm q}$ and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



| ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted) | | | | | | |
|--|----------------------------|-----------------------------------|-------------|------|--|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | | |
| Drain-source voltage | | V _{DS} | 40 | | | |
| Gate-source voltage | | V _{GS} | ± 20 | V | | |
| Continuous drain current | $T_C = 25 \ ^\circ C \ ^a$ | 1 | 150 | | | |
| | T _C = 125 °C | l _D | 125 | | | |
| Continuous source current (diode conductio | I _S | 136 | А | | | |
| Pulsed drain current ^b | | I _{DM} | 300 | | | |
| Single pulse avalanche current | L = 0.1 mH | I _{AS} | 60 | | | |
| Single pulse avalanche energy | L = 0.1 IIIH | E _{AS} | 180 | mJ | | |
| Maximum power dissipation ^b | T _C = 25 °C | D | 150 | W | | |
| | T _C = 125 °C | P _D | 50 | vv | | |
| Operating junction and storage temperature | range | T _J , T _{stg} | -55 to +175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------|------------------------|-------------------|-------|------|--|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | | |
| Junction-to-ambient | PCB mount ^c | R _{thJA} | 40 | °C/W | | |
| Junction-to-case (drain) | | R _{thJC} | 1 | 0/10 | | |

Notes

a. Package limited

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

c. When mounted on 1" square PCB (FR4 material)

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| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT | |
|---|----------------------|---|---|------|---------|---------|------|--|
| Static | | | | | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS}=0~V,~I_D=250~\mu A$ | | 40 | - | - | v | |
| Gate-source threshold voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$ | | 3.0 | 3.5 | v | |
| Gate-source leakage | I _{GSS} | V _{DS} = | 0 V, V_{GS} = ± 20 V | - | - | ± 100 | nA | |
| | | $V_{GS} = 0 V$ | V _{GS} = 0 V V _{DS} = 40 V - | | - | 1 | | |
| Zero gate voltage drain current | I _{DSS} | $V_{GS} = 0 V$ | V _{DS} = 40 V, T _J = 125 °C | - | - | 50 | μA | |
| | | $V_{GS} = 0 V$ | V _{DS} = 40 V, T _J = 175 °C | - | - | 300 | μA | |
| On-state drain current ^a | I _{D(on)} | $V_{GS} = 10 V$ | $V_{DS} \ge 5 V$ | 100 | - | - | Α | |
| | | $V_{GS} = 10 V$ | I _D = 35 A | - | 0.00133 | 0.00163 | | |
| Drain-source on-state resistance ^a | R _{DS(on)} | V _{GS} = 10 V | I _D = 35 A, T _J = 125 °C | - | - | 0.00268 | Ω | |
| | | V _{GS} = 10 V | I _D = 35 A, T _J = 175 °C | - | - | 0.00326 | 1 | |
| Forward transconductance b | 9 _{fs} | V _{DS} | = 15 V, I _D = 35 A | - | 143 | - | S | |
| Dynamic ^b | | | | | • | | | |
| Input capacitance | Ciss | | | - | 6783 | 9200 | | |
| Output capacitance | Coss | V _{GS} = 0 V V _{DS} = 25 V, f = 1 MHz | | - | 1771 | 2400 | pF | |
| Reverse transfer capacitance | C _{rss} | | | - | 109 | 150 | 1 | |
| Total gate charge ^c | Qg | | | - | 106 | 160 | | |
| Gate-source charge ^c | Q _{gs} | V _{GS} = 10 V | $V_{DS} = 20 \text{ V}, \text{ I}_{D} = 100 \text{ A}$ | - | 33 | - | nC | |
| Gate-drain charge ^c | Q _{gd} | | | | 21 | - | | |
| Gate resistance | Rg | f = 1 MHz | | 1.25 | 2.75 | 4.35 | Ω | |
| Turn-on delay time ^c | t _{d(on)} | | | - | 19 | 30 | | |
| Rise time ^c | t _r | V _{DD} = | = 20 V, R_L = 0.2 Ω | - | 194 | 300 | | |
| Turn-off delay time ^c | t _{d(off)} | I _D ≅ 100 A, | $I_D \cong 100 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | | 45 | 70 | - ns | |
| Fall time ^c | t _f | | | - | 26 | 40 | | |
| Source-Drain Diode Ratings and Charac | cteristics b | • | | | | | | |
| Pulsed current ^a | I _{SM} | | | - | - | 300 | A | |
| Forward voltage | V _{SD} | I _F = 60 A, V _{GS} = 0 V | | - | 0.83 | 1.5 | V | |
| Body diode reverse recovery time | t _{rr} | I _F = 30 A, di/dt = 100 A/μs | | - | 88 | 180 | ns | |
| Body diode reverse recovery charge | Q _{rr} | | | - | 186 | 380 | nC | |
| Reverse recovery fall time | ta | | | - | 57 | - | | |
| Reverse recovery rise time | t _b | | | - | 31 | - | ns | |
| Body diode peak reverse recovery current | I _{RM(REC)} | | | _ | -4.6 | - | A | |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

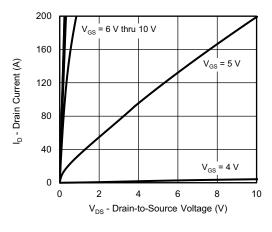
b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

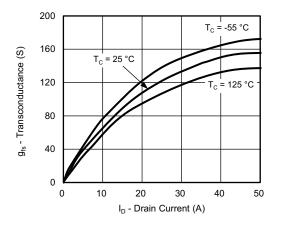
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



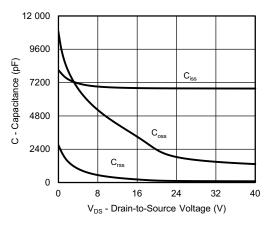
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



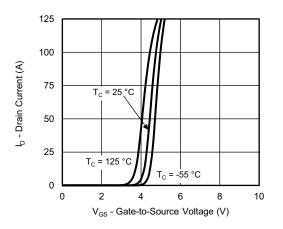
Output Characteristics



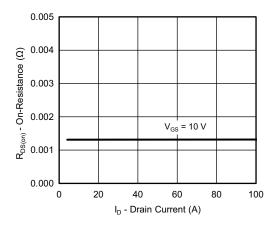
Transconductance



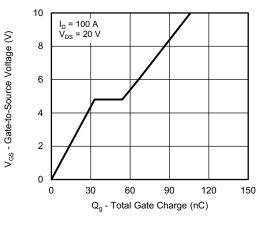
Capacitance



Transfer Characteristics



On-Resistance vs. Drain Current



Gate Charge

S18-0116-Rev. A, 29-Jan-18

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Document Number: 77695

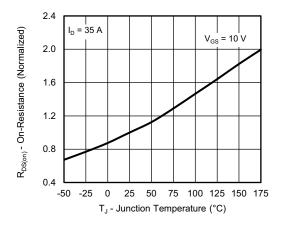
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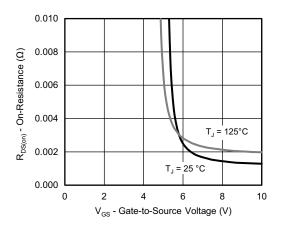
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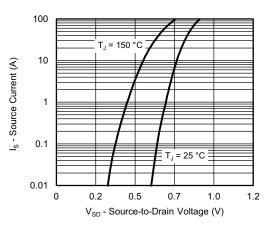
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



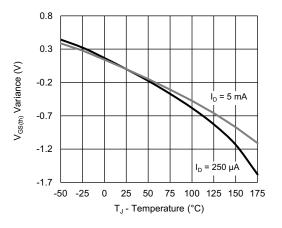
On-Resistance vs. Junction Temperature



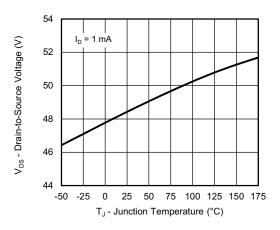
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage







Drain Source Breakdown vs. Junction Temperature

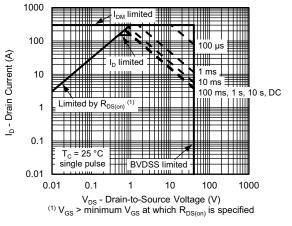
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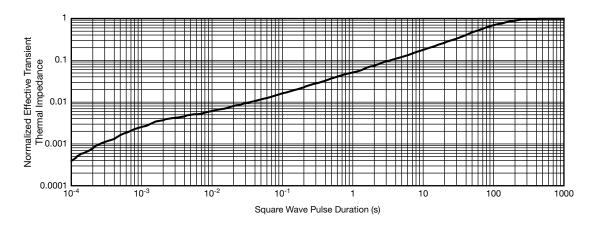
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Safe Operating Area



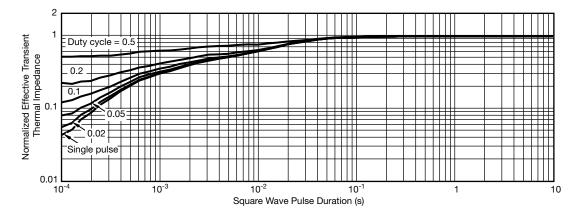
Normalized Thermal Transient Impedance, Junction-to-Ambient



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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

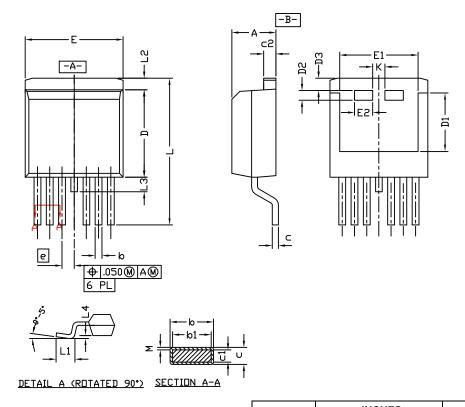
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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D²PAK (TO-263-7L) Case Outline



Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin to pin coplanarity max. 4 mils.
- 4. Lead thickness 25 mils.
- 5. For SUM part numbers lead thickness is 24 mils to 29 mils.
- 6. For reference only.
- 7. Use inches as the primary measurement.
- 8. This feature is only for SUM.

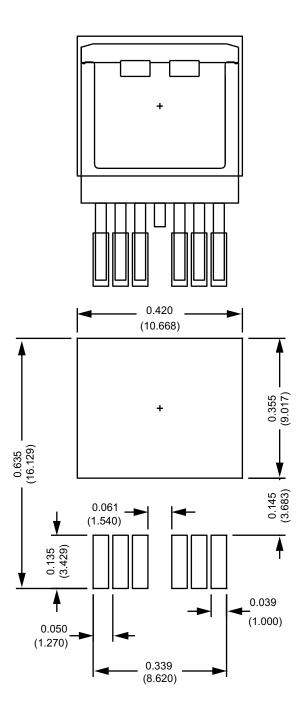
| | INCHES | | MILLIMETERS | | |
|--|-----------|-------|-------------|--------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| A | 0.160 | 0.190 | 4.064 | 4.826 | |
| b | 0.020 | 0.039 | 0.508 | 0.990 | |
| b1 | 0.020 | 0.035 | 0.508 | 0.889 | |
| b2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| c* SUB | 0.012 | 0.018 | 0.305 | 0.457 | |
| c* SUM | 0.022 | 0.028 | 0.559 | 0.711 | |
| c1 | 0.018 | 0.025 | 0.457 | 0.635 | |
| c2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| D | 0.340 | 0.380 | 8.636 | 9.652 | |
| D1 | 0.220 | 0.240 | 5.588 | 6.096 | |
| D2 | 0.038 | 0.042 | 0.965 | 1.067 | |
| D3 | 0.045 | 0.055 | 1.143 | 1.397 | |
| E | 0.380 | 0.410 | 9.652 | 10.414 | |
| E1 | 0.245 | - | 6.223 | - | |
| E2 | 0.072 | 0.078 | 1.829 | 1.981 | |
| е | 0.050 BSC | | 1.27 BSC | | |
| K | 0.045 | 0.055 | 1.143 | 1.397 | |
| L | 0.575 | 0.625 | 14.605 | 15.875 | |
| L1 | 0.090 | 0.110 | 2.286 | 2.794 | |
| L2 | 0.040 | 0.055 | 1.016 | 1.397 | |
| L3 | 0.050 | 0.070 | 1.270 | 1.778 | |
| L4 | 0.010 BSC | | 0.254 BSC | | |
| М | - | 0.002 | - | 0.050 | |
| ECN: T13-0709-Rev. B, 30-Sep-13 DWG: 6006 | | | | | |

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Recommended Land Pattern D²PAK (TO-263-7L)





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